

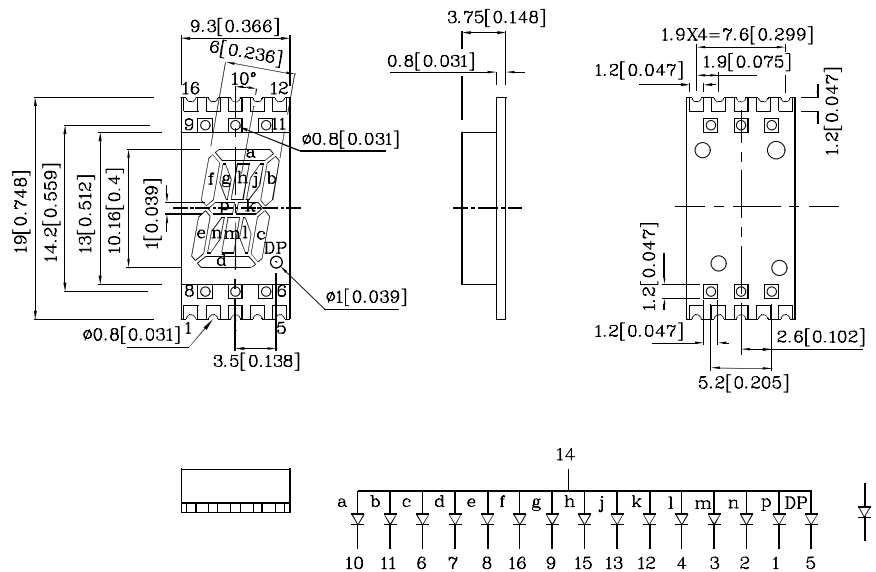
Features

- 0.4 inch digit height
- Robust package
- Low power consumption
- Standard configuration: Gray face w/ white segments
- Standard Package: 400pcs/ Reel
- MSL (Moisture Sensitivity Level): 2a
- RoHS compliant



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Package Schematics



Notes:

1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
2. Specifications are subject to change without notice.
3. The gap between the reflector and PCB shall not exceed 0.25mm.

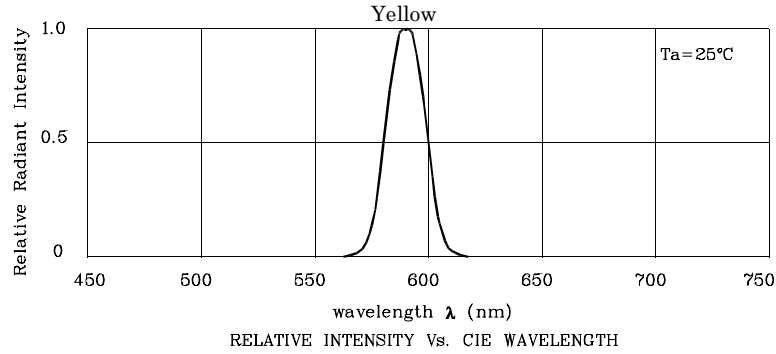
Absolute Maximum Ratings (T _A =25°C)		Yellow (AlGaInP)	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	175	mA
Power Dissipation	P _D	75	mW
Operating Temperature	T _A	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

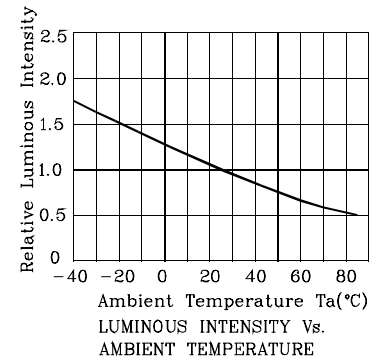
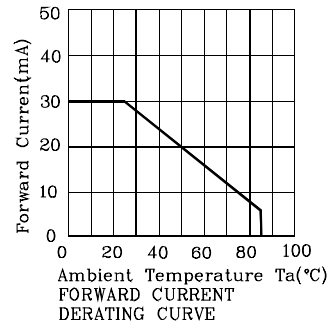
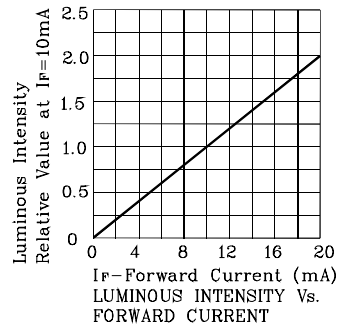
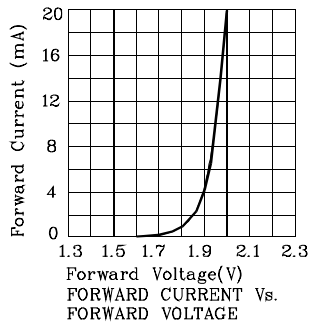
Operating Characteristics (T _A =25°C)		Yellow (AlGaInP)	Unit
Forward Voltage (Typ.) (I _F =10mA)	V _F	1.95	V
Forward Voltage (Max.) (I _F =10mA)	V _F	2.5	V
Reverse Current (Max.) (V _R =5V)	I _R	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	λP	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =10mA)	λD	590*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	△λ	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	C	20	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* (If=10mA) ucd		Wavelength CIE127-2007* nm λP	Description
			min.	typ.		
XZFAMYK10A	Yellow	AlGaInP	2100 5600*	45990 11990*	590*	Common Anode, Rt.Hand Decimal.

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

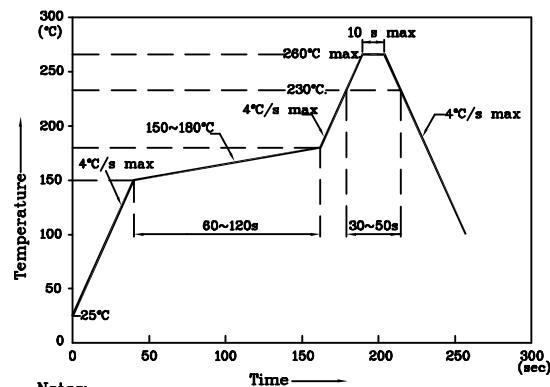


❖ Yellow

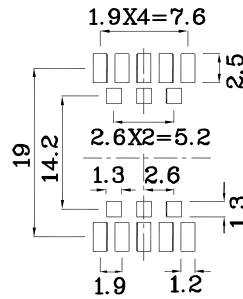


LED is recommended for reflow soldering and soldering profile is shown below.

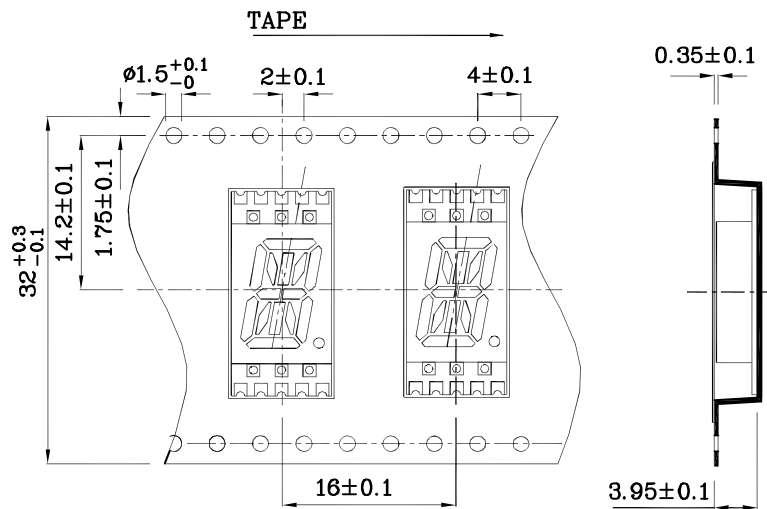
Reflow Soldering Profile for SMD Products (Pb-Free Components)



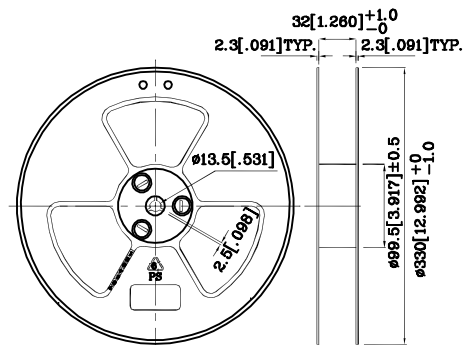
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.15)



❖ Tape Specification (Units : mm)



❖ Reel Dimension



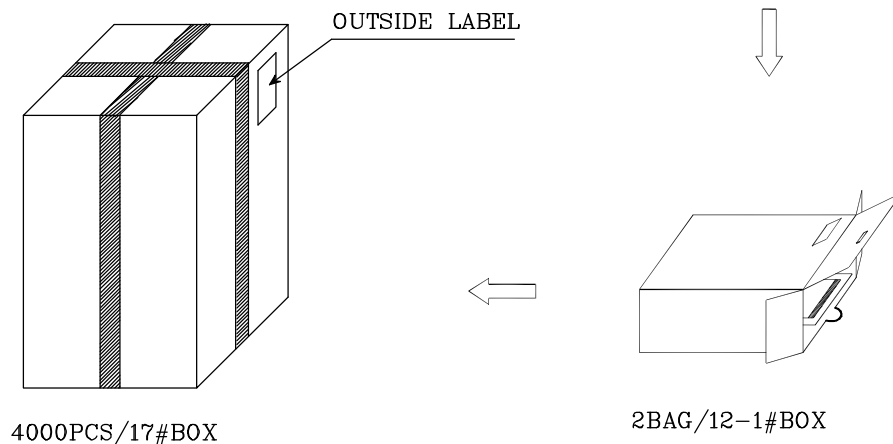
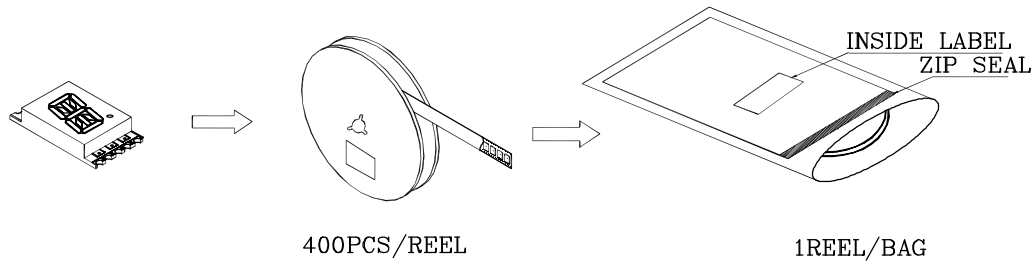
Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

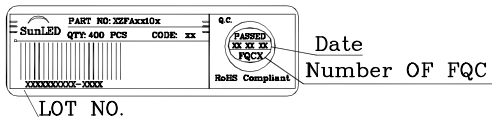
1. Wavelength: $\pm 1\text{nm}$
2. Luminous intensity / luminous flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

Note: Accuracy may depend on the sorting parameters.

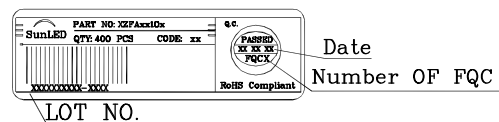
PACKING & LABEL SPECIFICATIONS



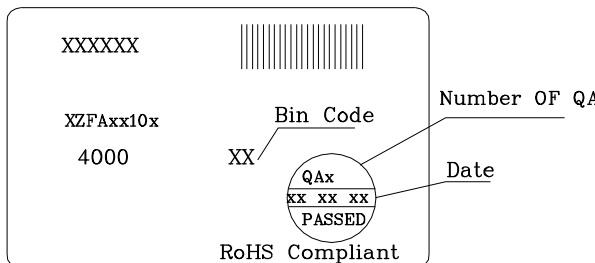
Inside Label On tape



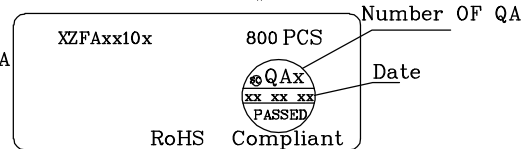
Outside Label On BAG



Outside Label On 19#Box



Outside Label On 12#Box



TERMS OF USE

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2. Contents within this document are subject to improvement and enhancement changes without notice.
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